ATTY. DOCKET NO. SERIAL NO. INFORMATION DISCLOSURE Not Yet Assigned P146-US **CITATION** APPLICANT Robert Duboc, et al. PTO-1449 GROUP Not Yet Assigned FILING DATE Herewith SHEET 1 OF 2 U.S. PATENT DOCUMENTS **EXAMINER'S** PATENT NO. DATE NAME **CLASS SUBCLASS FILING DATE** INITIALS U.S Pub App No. 1/2/03 Miller \mathcal{M} 2003/0002019 5/16/02 U.S Pub App No. Lopes, et al. 2002/0056898 U.S Pub App No. 5/30/02 Robbins, et al. 2002/0063322 6,300,294 10/9/01 Robbins, et al. 5,694,740 12/9/97 Martin, et al. 5,936,758 8/10/99 Fisher, et al. 5,610,438 3/11/97 Wallace, et al. M 5,512,374 4/30/96 Wallace, et al. FOREIGN PATENT DOCUMENTS TRANSLATION **EXAMINER'S** PATENT NO. DATE COUNTRY **CLASS SUBCLASS** INITIALS YES NO OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) "Lubrication of Digital Micromirror Devices" Henck, Tribology Letters 3 (1997) 239-247 m Micromotor Operation in a Liquid Environment" Dhuler, IEEE 1992 pgs 10-13 "Optimization of Lubricants fir silica Micromotors" Zarrd, Sensors and Actuators A 46-47 (1995) 598-600 "Fabrication of packaged thin beam structures by an improved driving method" Masato Ohtsu, ML IEEE (1996) 0-7803-2985-6, pgs 228-233 "Operation of electrostatic micromotors in liquid environments" Mehran Mehregany, J. Micromech. Microeng. 2 (1992) 1-3 M "Nanotribology and nanomechanics of MEMS devices", Nharad Bhushan, IEEE0-7803-298-5-6, pgs 91-98 "Micromotor dynamics in lubricating fluids" Keren Deng, J. Micromech. Microeng. 4 (1994) 266-269 "Stiction reduction processes for surface mairomachines" Roya Maboudian Tribology letters 3 M (1997) 215-221 "Friction and Pull-off Force on Silicon Surface Modified by FIB" Ando IEEE 1996, 0-7803-M2985-6/96, pgs 349-353 "Measurement of Micromoto Dynamics in Lubricating Fluids" Deng IEEE ML "Friction and Wear studies on Lubricants and materials Applicable to MEMS" Shigehisa Suzuki, IEEE 1991, pgs 143-147 **EXAMINER DATE CONSIDERED**

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